

AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

1.-11. (canceled)

12. (previously presented): An adhesive comprising one or more organic polymers and one or more paramagnetic or superparamagnetic nanoparticles having a particle size of from 1 to 1000 nm.

13. (previously presented): The adhesive of claim 12, comprising 0.1% to 50% by weight of the nanoparticles.

14. (canceled)

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15. (canceled)

16. (previously presented): The adhesive of claim 12, in the form of a pressure sensitive adhesive or a contact adhesive.

17. (previously presented): The adhesive of claim 12, in the form of a hot melt adhesive or a dispersion adhesive.

18. (previously presented): The adhesive of claim 12, wherein the one or more organic polymers comprise one or more synthetic organic polymers selected from the group consisting of polyacrylates, polymethacrylates, polyoxyalkylenes, polyurethanes, polyesters, polystyrene,

polyethylene, polyvinyl esters, ethylene-vinyl acetate copolymers, and mixtures thereof.

19. (previously presented): The adhesive of claim 18, wherein the one or more synthetic organic polymers comprise an ethylene-vinyl acetate copolymer or a mixture of two or more such copolymers.

20. (previously presented): The adhesive of claim 12, wherein one or more of the nanoparticles are bonded ionically, coordinatively or covalently to one or more of the organic polymers.

21. (previously presented): A process for preparing an adhesive composition, comprising combining and mixing one or more organic polymers and one or more paramagnetic or superparamagnetic nanoparticles, and optionally one or more solvents or further additives, to form the adhesive composition.

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22. (previously presented): A method of temporarily or permanently binding two or more substances together, comprising the steps of applying to one or more surfaces of the substrates an adhesive comprising one or more paramagnetic or superparamagnetic nanoparticles having a particle size of from 10 to 300 nm and contacting the one or more substrate surfaces with applied adhesive with one or more other surfaces of the substrates to bind the substrates.

23. (previously presented): The adhesive of claim 13, comprising 0.1% to 40% by weight of the nanoparticles.

24. (previously presented): The adhesive of claim 23, comprising 0.1% to 30% by weight of the nanoparticles.

25. (previously presented): The adhesive of claim 24, comprising 0.1% to 20% by weight of the nanoparticles.

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